

Rev. V1

Features

- · Suitable for Linear and Saturated Applications
- CW and Pulsed Operation: 100 W Output Power
- Internally Pre-Matched
- 260°C Reflow Compatible
- 50 V Operation
- 100% RF Tested
- RoHS* Compliant

Description

The MAGX-100027-100C0P is high power GaN on Si HEMT device optimized for DC - 2.7 GHz frequency operation. The device supports both CW and pulsed operation with peak output power levels of 100 W (50.0 dBm) in a plastic package.

The MAGX-100027-100C0P is ideally suited for a multitude of applications including military radio communications, digital cellular infrastructure, RF energy, avionics, test instrumentation and RADAR.

Typical Performance:

V_{DS} = 50 V, I_{DQ} = 200 mA, T_C = 25°C. Measured under pulsed load-pull at optimum efficiency load impedance, 2.5 dB Compression, 100 μs pulse width,1 ms period, 10% duty cycle.

Frequency (GHz)	Output Power ¹ (dBm)	Gain ² (dB)	η₀² (%)
0.9	51.8	21.0	73.5
1.4	52.8	17.8	66.8
2.0	52.5	16.0	70.1
2.5	52.1	16.3	74.2
2.7	51.1	15.1	59.0

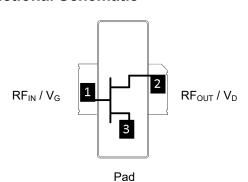
- 1. Load impedance tuned for maximum output power.
- 2. Load impedance tuned for maximum drain efficiency.

Ordering Information

Part Number	Package
MAGX-100027-100C0P	Bulk quantity
MAGX-100027-100CTP	Tape and Reel
MAGX-1A0027-100C0P	Sample board



Functional Schematic



Pin Configuration

Pin#	Pin Name	Function
1	RF _{IN} / V _G	RF Input / Gate
2	RF _{OUT} / V _D	RF Output / Drain
3	Pad ³	Ground / Source

3. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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RF Electrical Characteristics: T_C = 25°C, V_{DS} = 50 V, I_{DQ} = 200 mA Note: Performance in MACOM Evaluation Test Fixture, 50 Ω system

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Small Signal Gain	Pulsed ⁴ , 2.5 GHz	Gss	-	18.5	-	dB
Power Gain	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	G _{SAT}	-	16.6	-	dB
Saturated Drain Efficiency	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	η _{SAT}	-	67.4	-	%
Saturated Output Power	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	P _{SAT}	-	51.9	-	dBm
Gain Variation (-40°C to +85°C)	Pulsed ⁴ , 2.5 GHz	ΔG	-	0.02	-	dB/°C
Power Variation (-40°C to +85°C)	Pulsed ⁴ , 2.5 GHz	ΔP2.5dB	-	0.015	-	dBm/°C
Gain	Pulsed ⁴ , 2.5 GHz, P _{IN} = 34.0 dBm	G _P	-	17.3	-	dB
Drain Efficiency	Pulsed ⁴ , 2.5 GHz, P _{IN} = 34.0 dBm	η	-	67	-	%
Ruggedness: Output Mismatch	All phase angles	Ψ	VSWF	VSWR = 10:1, No Damage		age

RF Electrical Specifications: $T_A = 25^{\circ}C$, $V_{DS} = 50 \text{ V}$, $I_{DQ} = 200 \text{ mA}$ Note: Performance in MACOM Production Test Fixture, 50Ω system

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Power Gain	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	G _{SAT}	15	16.6	-	dB
Saturated Drain Efficiency	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	η _{SAT}	60	67.4	-	%
Saturated Output Power	Pulsed ⁴ , 2.5 GHz, 2.5 dB Gain Compression	P _{SAT}	50	51.5	-	dBm
Gain	Pulsed ⁴ , 2.5 GHz, P _{IN} = 34.0 dBm	G_P	15	17.3	-	dB
Drain Efficiency	Pulsed ⁴ , 2.5 GHz, P _{IN} = 34.0 dBm	η	60	66.9	-	%

^{4.} Pulse details: 100 µs pulse width, 1 ms period, 10% Duty Cycle.

DC Electrical Characteristics: T_A = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Drain-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 130 V	I _{DLK}	-	-	21.6	mA
Gate-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 0 V	I_{GLK}	-	1	21.6	mA
Gate Threshold Voltage	$V_{DS} = 50 \text{ V}, I_D = 21.6 \text{ mA}$	V_T	-2.6	-2.15	-1.6	V
Gate Quiescent Voltage	$V_{DS} = 50 \text{ V}, I_{D} = 200 \text{ mA}$	V_{GSQ}	-2.4	-2.05	-1.4	V
On Resistance	$V_{GS} = 2 \text{ V}, I_D = 200 \text{ mA}$	R _{ON}	-	0.22	-	Ω
Maximum Drain Current	V_{DS} = 7 V pulsed, pulse width 300 µs	I _{D, MAX}	-	13.0	-	Α



Absolute Maximum Ratings^{5,6,7,8,9}

Parameter	Absolute Maximum			
Drain Source Voltage, V _{DS}	130 V			
Gate Source Voltage, V _{GS}	-10 to 3 V			
Gate Current, I _G	43 mA			
Storage Temperature Range	-65°C to +150°C			
Case Operating Temperature Range	-40°C to +85°C			
Channel Operating Temperature Range, T _{CH}	-40°C to +225°C			
Absolute Maximum Channel Temperature	+250°C			

^{5.} Exceeding any one or combination of these limits may cause permanent damage to this device.

Thermal Characteristics 10

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis	$V_{DS} = 50 \text{ V},$ $T_{C} = 85^{\circ}\text{C}, T_{CH} = 225^{\circ}\text{C}$	$R_{\theta}(FEA)$	1.56	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature	$V_{DS} = 50 \text{ V},$ $T_{C} = 85^{\circ}\text{C}, T_{CH} = 225^{\circ}\text{C}$	$R_{\theta}(IR)$	1.25	°C/W

^{10.}Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1B, CDM Class C3 devices.

^{6.} MACOM does not recommend sustained operation above maximum operating conditions.

 ^{7.} Operating at drain source voltage V_{DS} < 55 V will ensure MTTF > 1 x 10⁷ hours.
8. Operating at nominal conditions with T_{CH} ≤ 225°C will ensure MTTF > 1 x 10⁷ hours.
9. MTTF may be estimated by the expression MTTF (hours) = A e [B + C/(T+273)] where *T* is the channel temperature in degrees Celsius, A = 3.686, B = -35.00, and C = 25,416.

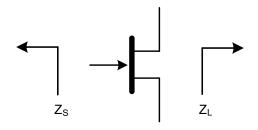


Pulsed⁴ Load-Pull Performance Reference Plane at Device Leads

		Maximum Output Power					
		V _{DS} = 50 V, I _{DQ} = 200 mA, T _C = 25°C, P2.5dB					
Frequency (GHz)	Z _{source} (Ω)	Z _{LOAD} ¹¹ (Ω)	Gain (dB)	P _{OUT} (dBm)	P _{OUT} (W)	η _□ (%)	AM/PM ¹³ (°)
0.9	6 - j1.5	4.8 + j1.5	21.0	51.8	150.6	61.4	1.8
1.4	6 - j2.0	4.5 + j1.9	17.8	52.8	191.9	62.8	0.6
2.0	6 - j4.6	3.1 + j0.0	16.0	52.5	177.8	62.5	-3.5
2.5	6 - j5.5	2.4 - j0.4	16.3	52.1	162.2	68.0	-9.8
2.7	6 - j4.0	2.0 - j1.1	15.1	51.7	148.2	55.1	-4.2

		Maximum Drain Efficiency					
			V _{DS} = 50 V, I _{DQ} = 200 mA, T _C = 25°C, P2.5dB				
Frequency (GHz)	Z _{source} (Ω)	Z _{LOAD} ¹² (Ω)	Gain (dB)	P _{OUT} (dBm)	P _{OUT} (W)	η₀ (%)	AM/PM ¹³ (°)
0.9	6 - j1.5	6.8 + j6.8	22.6	49.9	99.3	73.5	0.2
1.4	6 - j2.0	3.8 + j3.4	19.1	52.2	167.6	66.8	-5.8
2.0	6 - j4.6	2.2 + j2.0	17.9	51.0	125.9	70.1	-3.2
2.5	6 - j5.5	1.8 + j0.9	17.5	50.3	107.2	74.2	-11.0
2.7	6 - j4.0	1.3 + j0.1	16.7	50.1	102.3	59.0	-5.2

Impedance Reference



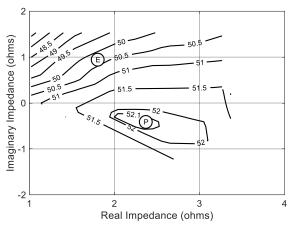
- $Z_{\mbox{\scriptsize SOURCE}}$ = Measured impedance presented to the input of the device at package reference plane.
- Z_{LOAD} = Measured impedance presented to the output of the device at package reference plane.
- 11. Load Impedance for optimum output power.12. Load Impedance for optimum efficiency.
- 13. AM/PM are relative values.



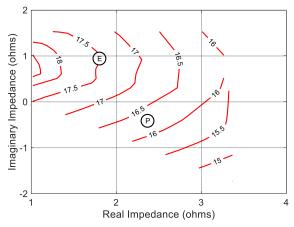
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Pulsed⁴ Load-Pull Performance 2.5 GHz

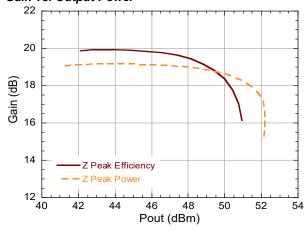
P2.5dB Loadpull Output Power Contours (dBm)



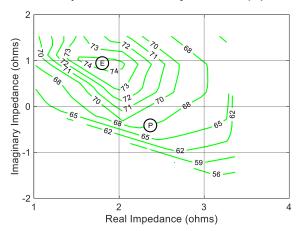
P2.5dB Loadpull Gain Contours (dB)



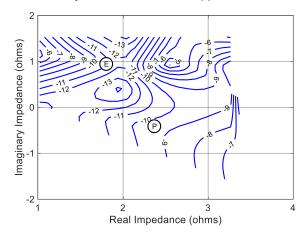
Gain vs. Output Power



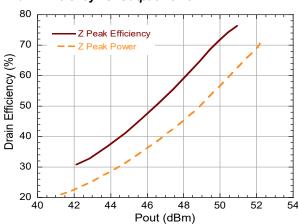
P2.5dB Loadpull Drain Efficiency Contours (%)



P2.5dB Loadpull AM/PM Contours (°)



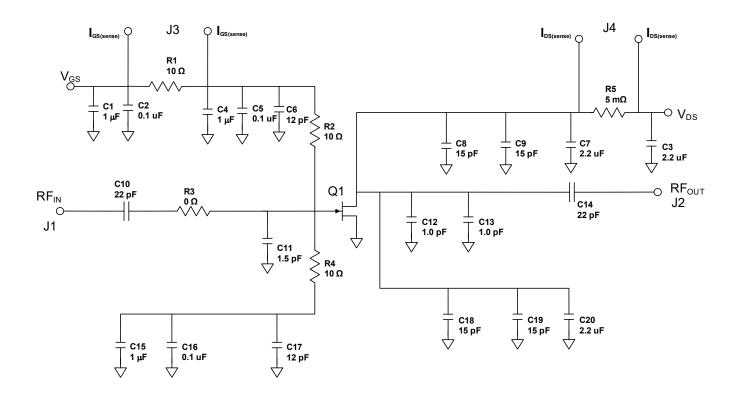
Drain Efficiency vs. Output Power





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Evaluation Test Fixture and Recommended Tuning Solution 2.45 - 2.55 GHz



Description

Parts measured on evaluation board (20-mil thick RO4350). Matching is provided using a combination of lumped elements and transmission lines as shown in the simplified schematic above. Recommended tuning solution component placement, transmission lines, and details are shown on the next page.

Bias Sequencing Turning the device ON

- 1. Set V_{GS} to pinch-off (V_P).
- Turn on V_{DS} to nominal voltage (50 V).
- 3. Increase V_{GS} until I_{DS} current is reached.
- 4. Apply RF power to desired level.

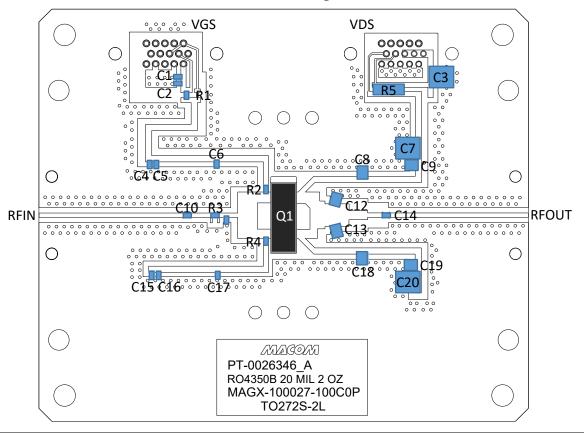
Turning the device OFF

- 1. Turn the RF power off.
- 2. Decrease V_{GS} down to V_P pinch-off.
- 3. Decrease V_{DS} down to 0 \dot{V} .
- 4. Turn off V_{GS}.



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Evaluation Test Fixture and Recommended Tuning Solution 2.45 - 2.55 GHz



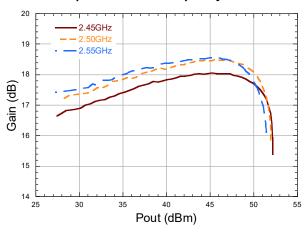
Reference Designator	Value	Tolerance Manufacturer		Part Number
C1, C4, C15	1.0 µF	+/- 10 %	Murata	GRM21BC72A105KE01L
C2, C5, C16	0.1 μF	+/- 10 %	Murata	GCD21BR72A104KA01L
C3, C7, C20	2.2 µF	+/- 10 %	Murata	KRM55TR72E225MH01L
C6, C17	12 pF	+/- 0.1 pF	PPI	0505C120BW151X
C8, C9, C18, C19	15 pF	+/- 0.1 pF	PPI	1111N150BW501X
C10, C14	22 pF	+/- 0.1 pF	PPI	0505C220BW151X
C11	1.5 pF	+/- 0.1 pF	PPI	0505C1R5BW151X
C12, C13	1 pF	+/- 0.1 pF	PPI	1111N1R0BW501X
R1, R2, R4	10 Ω	+/- 1 %	Vishay Dale	CRCW080510R0FKTA
R3	0 Ω	+/- 1 %	Vishay Dale	CRCW08050000Z0EAHP
R5	5 mΩ	+/- 1 %	Susumu	RL7520WT-R005-F
Q1	MACOM GaN Power Amplifier			MAGX-100027-100C0P
PCB	Rogers RO4350, 20mil, 2oz Cu, Au Finish			



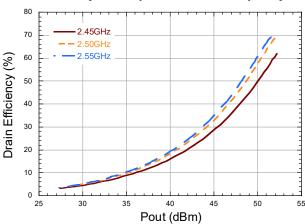
Rev. V

Typical Performance Curves as Measured in the 2.45 - 2.55 GHz Evaluation Test Fixture: Pulsed 4 2.5 GHz, V_{DS} = 50 V, I_{DQ} = 200 mA, T_C = 25°C Unless Otherwise Noted

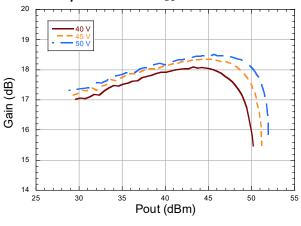
Gain vs. Output Power and Frequency



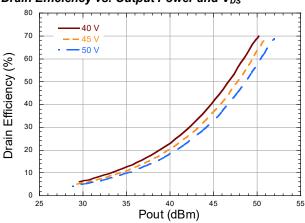
Drain Efficiency vs. Output Power and Frequency



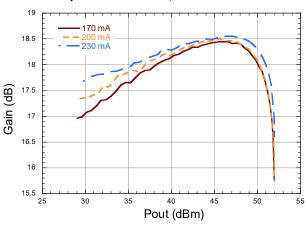




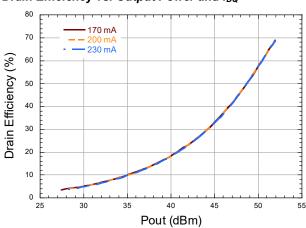
Drain Efficiency vs. Output Power and V_{DS}



Gain vs. Output Power and IDQ



Drain Efficiency vs. Output Power and IDQ

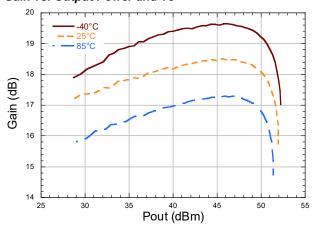




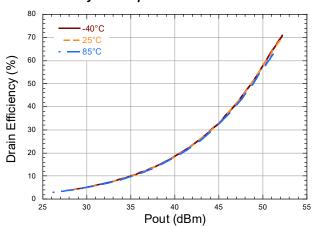
Rev. V

Typical Performance Curves as Measured in the 2.45 - 2.55 GHz Evaluation Test Fixture: Pulsed 4 2.5 GHz, V_{DS} = 50 V, I_{DQ} = 200 mA, T_C = 25°C Unless Otherwise Noted

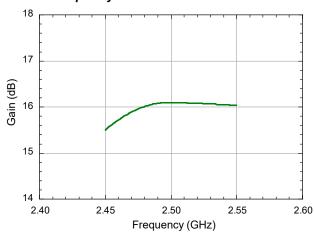
Gain vs. Output Power and Tc



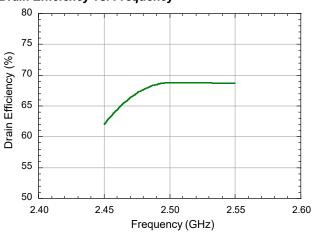
Drain Efficiency vs. Output Power and Tc



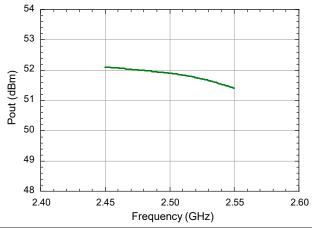
Gain vs. Frequency



Drain Efficiency vs. Frequency



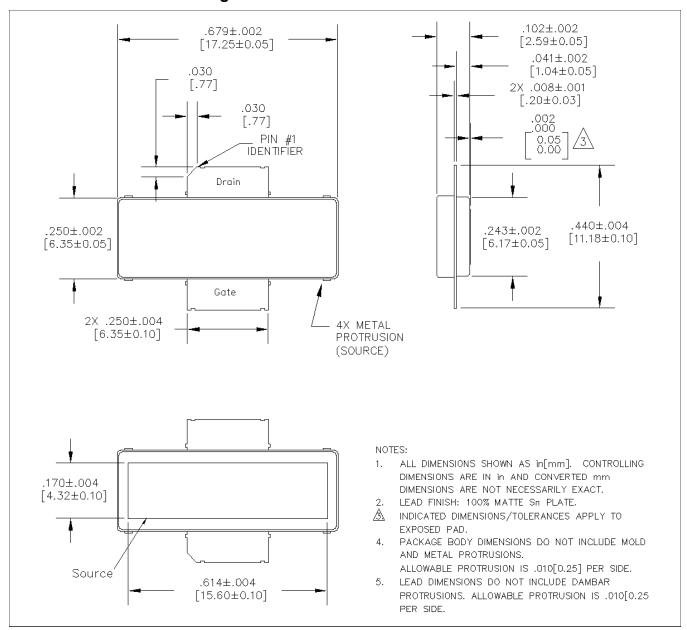
Output Power vs. Frequency





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Lead-Free TO-272S-2 Package Dimensions[†]



[†] Reference Application Note AN0004125 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 3 requirements. Plating is Matte Sn.

GaN Amplifier 50 V, 100 W DC - 2.7 GHz



MAGX-100027-100C0P

Rev. V'

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